



GaAs pHEMT MMIC LOW NOISE AMPLIFIER, 24 - 43.5 GHz

Typical Applications

This HMC1040LP3BE is ideal for:

- Point-to-Point Radios
- Test Instrumentation
- SatCom Transponders & VSAT
- · Industrial Sensors
- EW & ECM Subsystems

Features

Low Noise Figure: 2.2 dB

High Gain: 23 dB

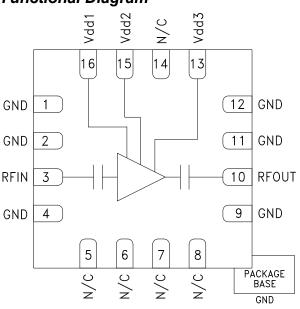
P1dB Output Power: +12 dBm Single Supply: +2.5V @ 70 mA

Output IP3: +22 dBm

50 Ohm Matched Input/Output

16 Lead 3x3 mm SMT Package: 16mm²

Functional Diagram



General Description

The HMC1040LP3CE is a self-biased GaAs MMIC Low Noise Amplifier housed in a leadless 3x3 mm plastic surface mount package. The amplifier operates between 24 and 43.5 GHz, delivering 23 dB of small signal gain, 2.2 dB noise figure, and output IP3 of +22 dBm, while requiring only 70 mA from a +2.5 V supply. The P1dB output power of +12 dBm enables the LNA to function as a LO driver for many of Hittite's balanced, I/Q and image reject mixers. The HMC1040LP3CE features I/Os that are DC blocked and internally matched to 50 Ohms, and is ideal for high capacity microwave radios and VSAT applications.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vdd1 = Vdd2 = Vdd3 = +2.5V, Idd = 70 mA

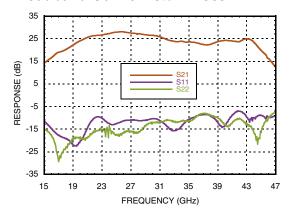
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range	24 - 27.5		27.5 - 33.5		33.5 - 43.5			GHz		
Gain [1]	22	25		20	23		17	20		dB
Gain Variation over Temperature		0.022			0.021			0.021		dB /°C
Noise Figure [1]		2.7	3.2		2.2	2.7		2.7	3.2	dB
Input Return Loss		11			12			10		dB
Output Return Loss		16			13			10		dB
Output Power for 1 dB Compression		12			12			12		dBm
Saturated Output Power (Psat)		14			14			14		dBm
Output Third Order Intercept (IP3)		22			22			24		dBm
Supply Current (Idd) (Vdd = 2.5V)		70	85		70	85		70	85	mA
[1] Board loss subtracted out.								•		



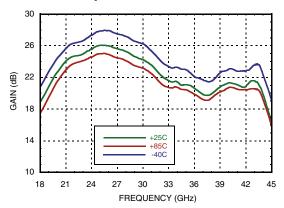


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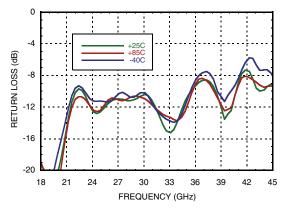
Broadband Gain & Return Loss [1]



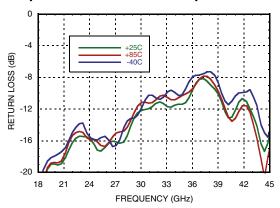
Gain vs. Temperature [1]



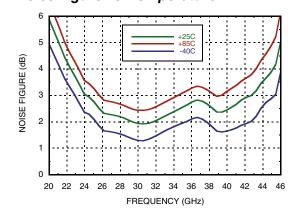
Input Return Loss vs. Temperature



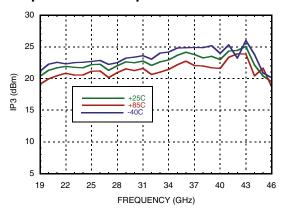
Output Return Loss vs. Temperature



Noise Figure vs. Temperature [1]



Output IP3 vs. Temperature



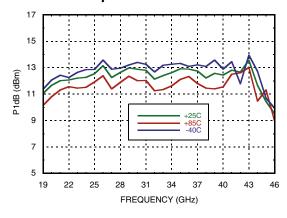
[1] Board loss subtracted out, gain only.



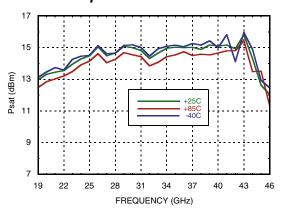


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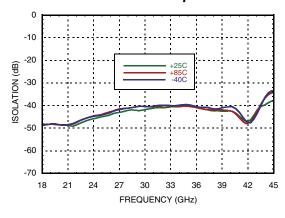
P1dB vs. Temperature



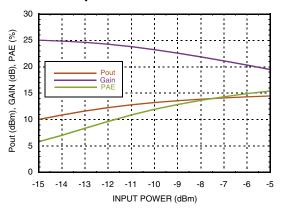
Psat vs. Temperature



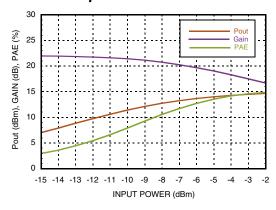
Reverse Isolation vs. Temperature



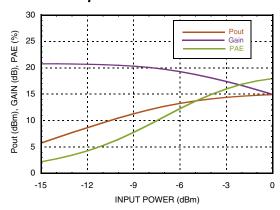
Power Compression @ 25 GHz



Power Compression @ 33 GHz



Power Compression @ 42 GHz

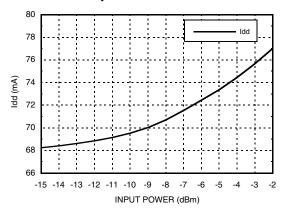






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Current vs. Input Power @ 33 GHz



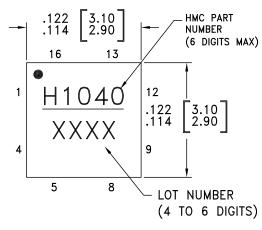
Absolute Maximum Ratings

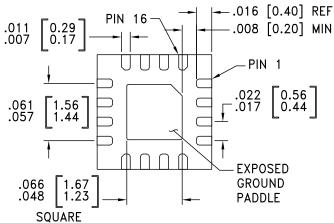
Drain Bias Voltage	+4V
RF Input Power	+5 dBm
Channel Temperature	175 °C
Continuous Pdiss (T = 85 °C) (derate 5.46 mW/°C above 85 °C)	0.49 W
Thermal Resistance (Channel to ground paddle)	183 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 0, 100 V

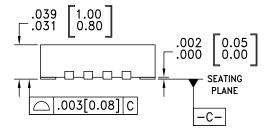


ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**

Outline Drawing BOTTOM VIEW







NOTES:

- 1 PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
- 2. LEAD AND GROUND PADDLE MATERIAL: COPPER ALLOY.
- 3. LEAD AND GROUND PADDLE PLATING: 100% MATTE TIN
- 4. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 5. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 6. PAD BURR LENGTH SHALL BE 0.15mm MAX. PAD BURR HEIGHT SHALL
- 7. PACKAGE WARP SHALL NOT EXCEED 0.05mm
- 8. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 9. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED PCB LAND

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC1040LP3CE	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [1]	<u>H1040</u> XXXX

[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX



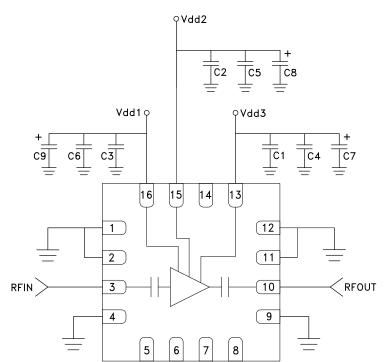


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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 2, 4, 9, 11, 12	GND	These pins and package bottom must be connected to RF/DC ground.	GND
3	RFIN	This pin AC coupled and matched to 50 Ohms	RFIN Ο ESD(5kΩ)
5-8, 14	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
10	RFOUT	This pin AC coupled and matched to 50 Ohms	RFOUT ESD(5kΩ)
13, 15, 16	Vdd3, Vdd2, Vdd1	Drain bias voltages for the amplifier. See Application Circuit for required external componnets.	Vdd1,2,3

Application Circuit



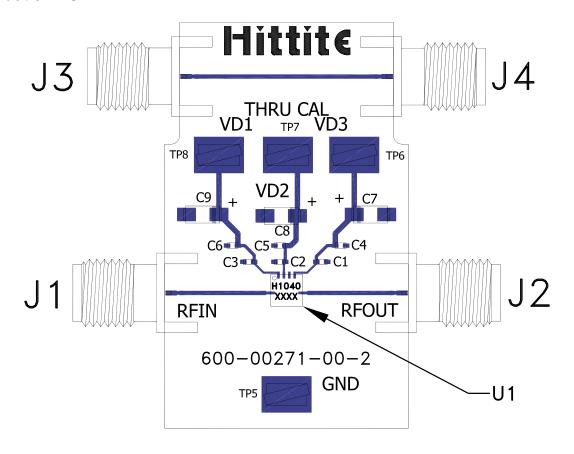
Capacitor	Value
C1 - C3	100 pF
C4 - C6	10 nF
C7 - C9	4.7 μF





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Evaluation PCB



List of Material for Evaluation PCB EVAL01-HMC1040LP3CE [1]

Item	Description
J1-J4	2.92 mm Connectors
TP5-TP8	Test Points DC Pin
C1 - C3	100 pF Capacitor, 0402 Pkg.
C4 - C6	10 nF Capacitor, 0402 Pkg.
C7 - C9	4.7 μF Capacitor, Tantalum
U1	HMC1040LP3CE Amplifier
PCB [2]	600-00271-00-2 Evaluation PCB

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350 or Arlon 25FR

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ADF7021DBJZ EVAL-ADF7021DBZ2 EVAL-ADF7021DBZ6 EVAL-ADF7021-NDBZ2 EVAL-ADF7021-VDB3Z EVAL-ADF7023DB3Z

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EVALZ ADL5369-EVALZ 130437-HMC1010LP4E 131352-HMC1021LP4E 131372-HMC951LP4E 130436-HMC1010LP4E

DEMOBOARD-U2790B ATR2406-PNQW EKIT01-HMC1197LP7F Si4705-D60-EVB Si4835-Demo LMV228SDEVAL SKYA21001-EVB

SMP1331-08-EVB EV1HMC618ALP3 EV1HMC641ALC4 EV1HMC8410LP2F EVAL_PAN4555ETU EVAL01-HMC1041LC4